



### Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

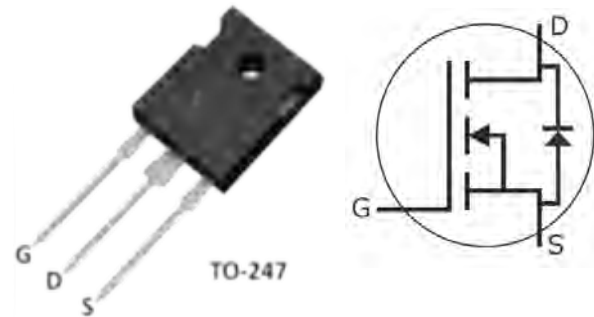
### Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

### Applications

- Auxiliary Power Supplies
- Switch Mode Power Supplies

$V_{DS}$	=	1700 V
$R_{DS(on)}$	=	1.0Ω
$I_D@25^{\circ}C$	=	5 A



TO-247-3L

### Maximum Ratings ( $T_c=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{DSmax}$	Drain-Source Voltage	1700	V	$V_{GS}=0V, I_D=100\mu A$	
$V_{GSmax}$	Gate-Source Voltage	-10/+25	V	Absolute maximum values	
$V_{GSop}$	Gate-Source Voltage	-5/+20	V	Recommended operational values	
$I_D$	Continuous Drain Current	5.0	A	$V_{GS}=20V, T_c=25^{\circ}C$	
		3.5		$V_{GS}=20V, T_c=100^{\circ}C$	
$I_{D(pulse)}$	Pulsed Drain Current	6.0	A	Pulse width $t_p$ limited by $T_{Jmax}$	
$P_D$	Power Dissipation	69	W	$T_c=25^{\circ}C, T_J=150^{\circ}C$	
$T_J, T_{STG}$	Operating Junction and Storage Temperature	-55 to +150	$^{\circ}C$		

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.


**Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	1700	/	/	V	V <sub>GS</sub> =0V, I <sub>D</sub> =100μA	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.5	3.0	4.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =1mA	
		/	2.2	/		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =1mA, T <sub>J</sub> =150°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	/	1	100	μA	V <sub>DS</sub> =1700V, V <sub>GS</sub> =0V	
I <sub>GSS+</sub>	Gate-Source Leakage Current	/	/	250	nA	V <sub>DS</sub> =0V, V <sub>GS</sub> =25V	
I <sub>GSS-</sub>	Gate-Source Leakage Current	/	/	250	nA	V <sub>DS</sub> =0V, V <sub>GS</sub> =-10V	
R <sub>DS(on)</sub>	Drain-Source On-State Resistance	/	1.0	1.3	Ω	V <sub>GS</sub> =20V, I <sub>D</sub> =2A	
		/	1.5	/		V <sub>GS</sub> =20V, I <sub>D</sub> =2A, T <sub>J</sub> =150°C	
g <sub>fs</sub>	Transconductance	/	1.15	/	S	V <sub>DS</sub> =20V, I <sub>D</sub> =2 A	
		/	1.30	/		V <sub>DS</sub> =20V, I <sub>D</sub> =2A, T <sub>J</sub> =150°C	
C <sub>iss</sub>	Input Capacitance	/	186	/	pF	V <sub>GS</sub> =0V	
C <sub>oss</sub>	Output Capacitance	/	12	/		V <sub>DS</sub> =1000V	
C <sub>rss</sub>	Reverse Transfer Capacitance	/	1.6	/		f=1MHz	
E <sub>OSS</sub>	C <sub>oss</sub> Stored Energy	/	6.2	/	μJ	V <sub>AC</sub> =25mV	
E <sub>ON</sub>	Turn-On Switching Energy	/	48	/		V <sub>DS</sub> =1200V, V <sub>GS</sub> =-5V/20V	
E <sub>OFF</sub>	Turn-Off Switching Energy	/	18	/		I <sub>D</sub> =2A, R <sub>G(ext)</sub> =2.5Ω, L=1500μH	
t <sub>d(on)</sub>	Turn-On Delay Time	/	5.2	/	ns	V <sub>DS</sub> =1200V, V <sub>GS</sub> =-5V/20V, I <sub>D</sub> =2A R <sub>G(ext)</sub> =2.5Ω, R <sub>L</sub> =600Ω	
t <sub>r</sub>	Rise Time	/	9.4	/			
t <sub>d(off)</sub>	Turn-Off Delay Time	/	13.2	/			
t <sub>f</sub>	Fall Time	/	22.0	/			
R <sub>G</sub>	Internal Gate Resistance	/	22	/	Ω	f=1MHz open drain	
Q <sub>GS</sub>	Gate to Source Charge	/	5.2	/	nC	V <sub>DS</sub> =1200V	
Q <sub>GD</sub>	Gate to Drain Charge	/	7.3	/		V <sub>GS</sub> =-5V/20V	
Q <sub>G</sub>	Total Gate Charge	/	21.8	/		I <sub>D</sub> =2A	

**Reverse Diode Characteristics**

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V <sub>SD</sub>	Diode Forward Voltage	4.2	/	V	V <sub>GS</sub> =-5V, I <sub>SD</sub> =1A	
		3.9	/		V <sub>GS</sub> =-5V, I <sub>SD</sub> =1A, T <sub>J</sub> =150°C	
I <sub>S</sub>	Continuous Diode Forward Current	/	4	A	T <sub>c</sub> =25°C	
t <sub>rr</sub>	Reverse Recover Time	25	/	ns	V <sub>GS</sub> =-5V, V <sub>R</sub> =1200V, I <sub>SD</sub> =2A	
Q <sub>rr</sub>	Reverse Recovery Charge	15	/	nC		
I <sub>rrm</sub>	Peak Reverse Recovery Current	2.8	/	A		

**Thermal Characteristics**

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
R <sub>θJC</sub>	Thermal Resistance from Junction to Case	1.8	2.0	°C/W		

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handling procedures.

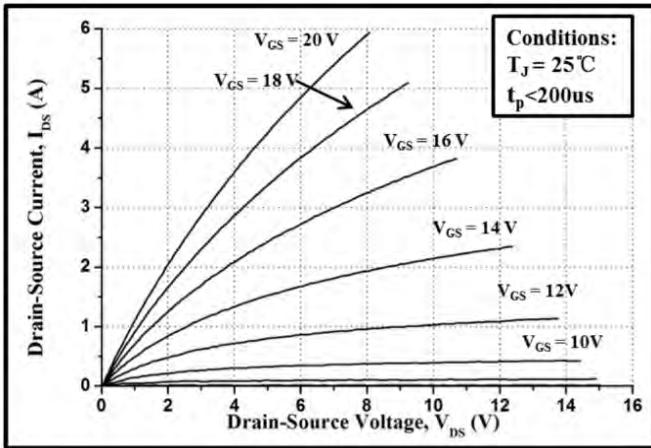


Figure 1. Typical Output Characteristics  $T_J = 25^\circ\text{C}$

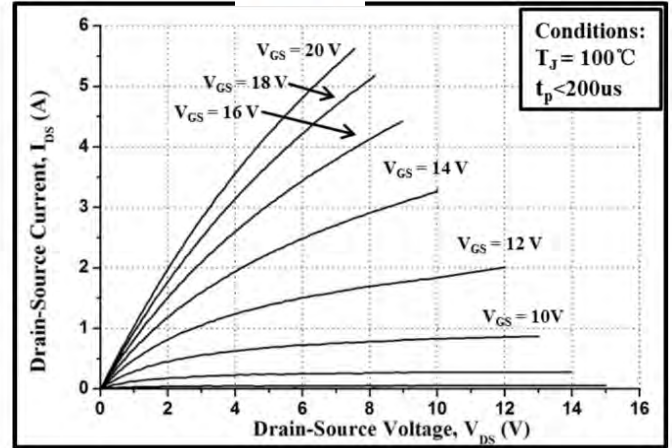


Figure 2. Typical Output Characteristics  $T_J = 100^\circ\text{C}$

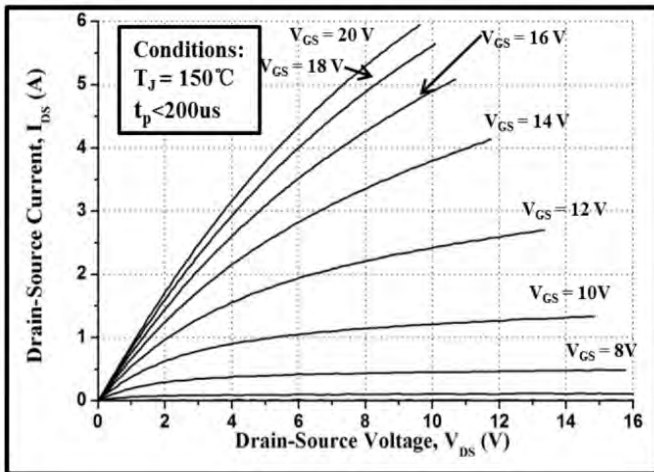


Figure 3. Typical Output Characteristics  $T_J = 150^\circ\text{C}$

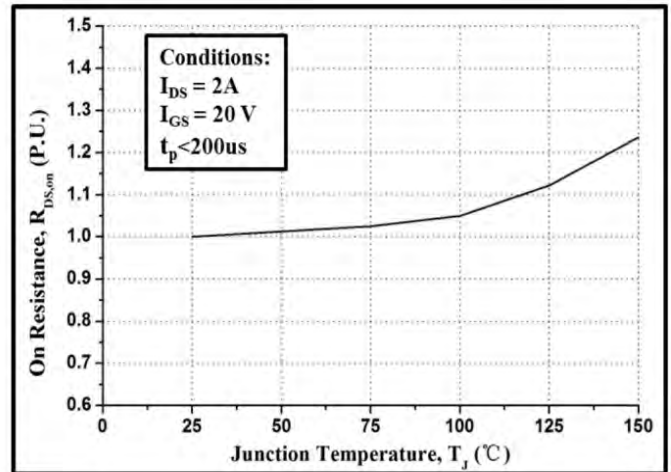


Figure 4. Normalized On-Resistance vs. Temperature

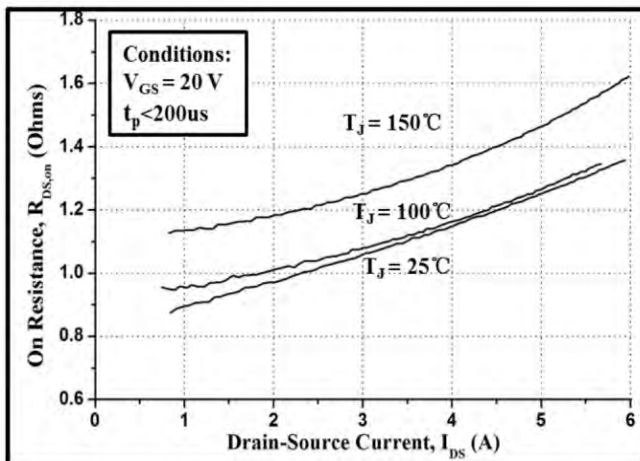


Figure 5. On-Resistance vs. Drain Current

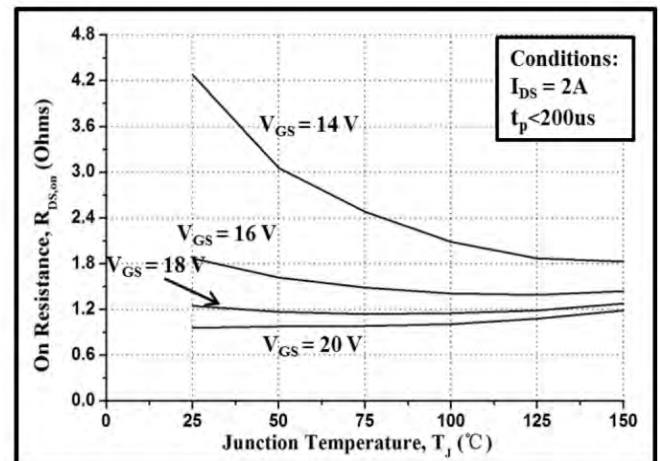


Figure 6. On-Resistance vs. Temperature

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handling procedures.

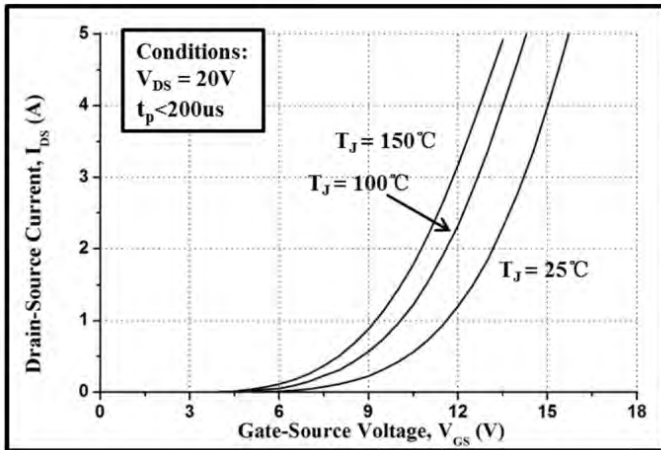


Figure 7. Typical Transfer Characteristics

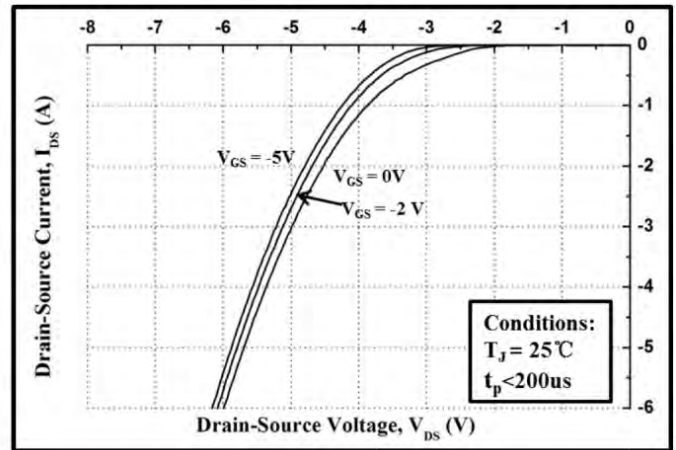


Figure 8. Body Diode Characteristics at 25°C

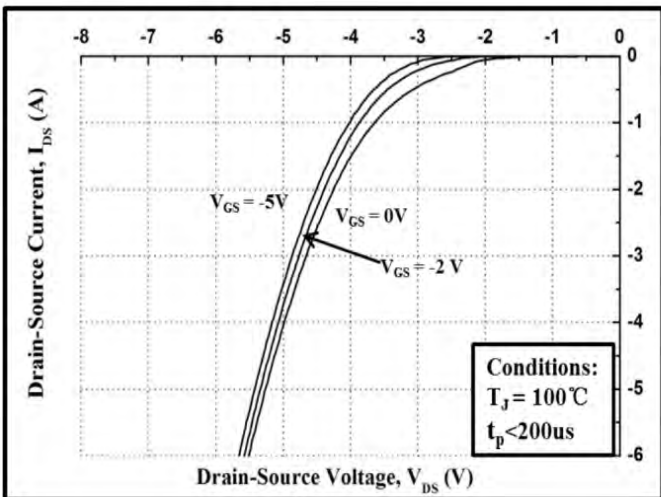


Figure 9. Body Diode Characteristics at 100°C

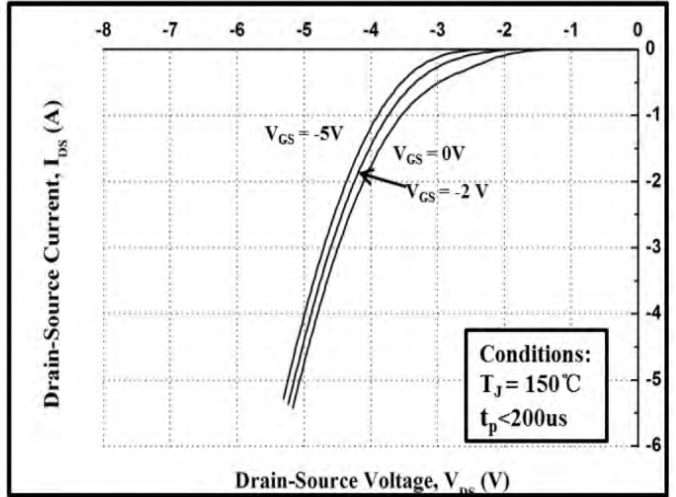


Figure 10. Body Diode Characteristics at 150°C

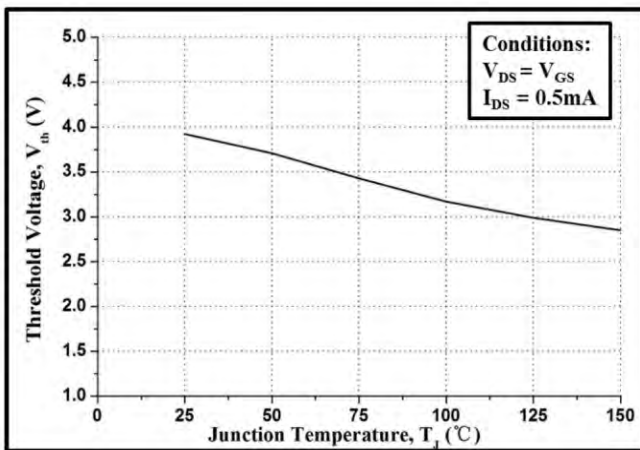


Figure 11. Gate Threshold Voltage vs. Temperature

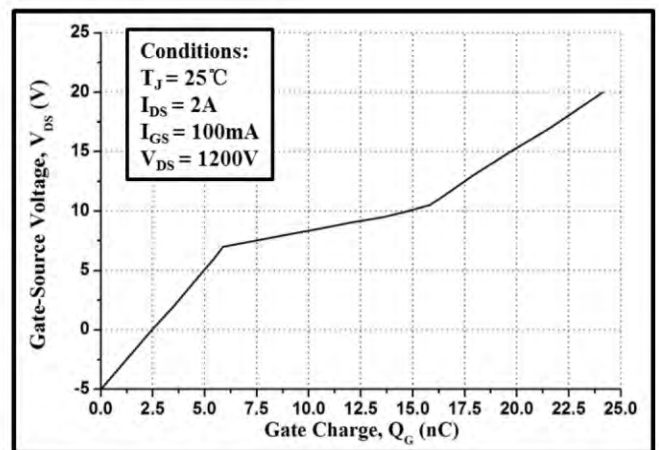


Figure 12. Gate Charge Characteristic

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures.

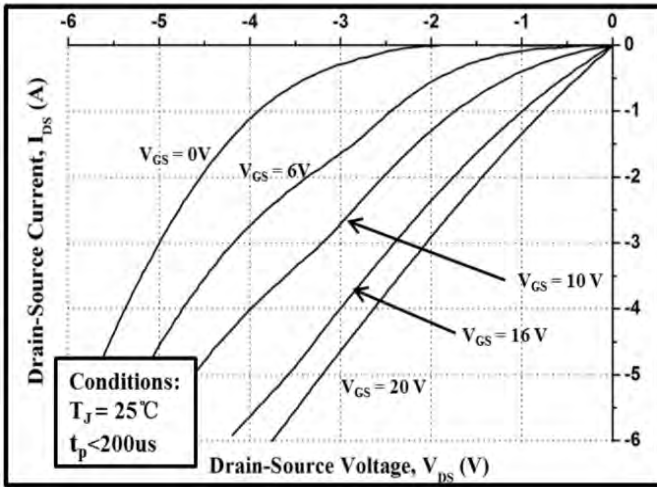


Figure 13. 3<sup>rd</sup> Quadrant Characteristics at 25°C

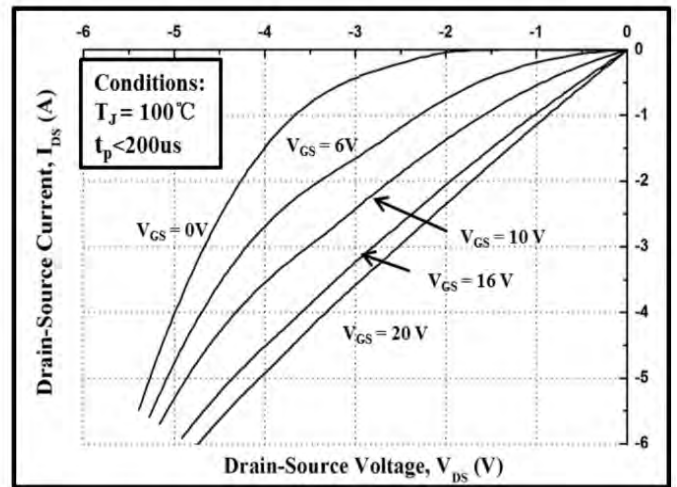


Figure 14. 3<sup>rd</sup> Quadrant Characteristics at 100°C

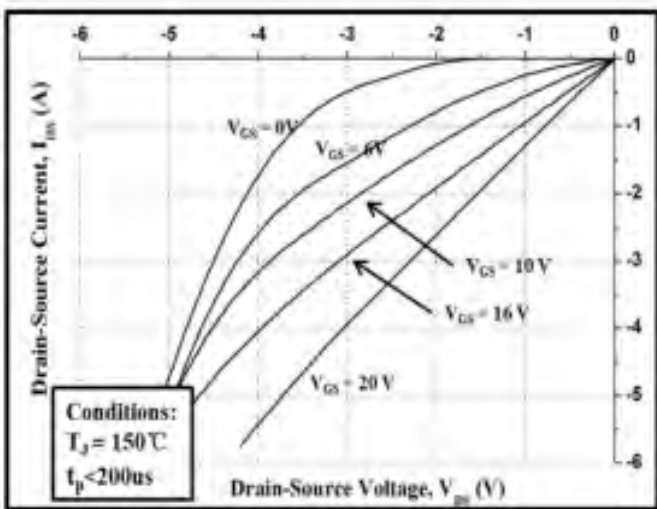


Figure 15. 3<sup>rd</sup> Quadrant Characteristics at 150°C

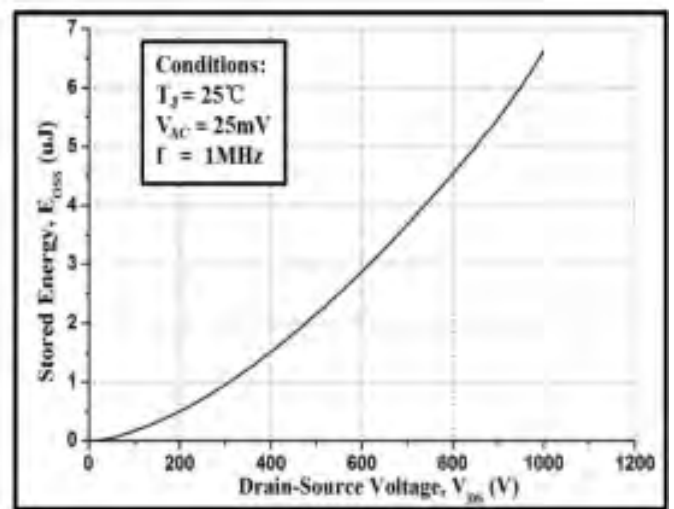


Figure 16. Output Capacitor Stored Energy

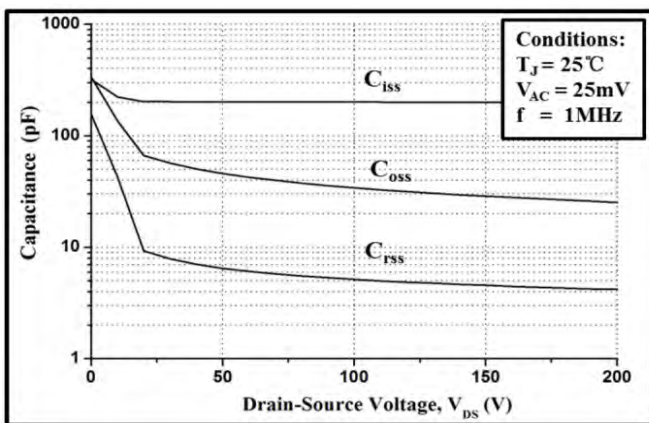


Figure 17. Capacitances vs. Drain-Source Voltage

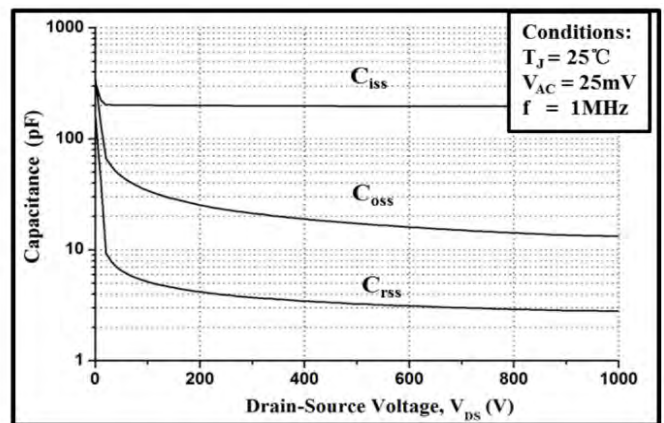


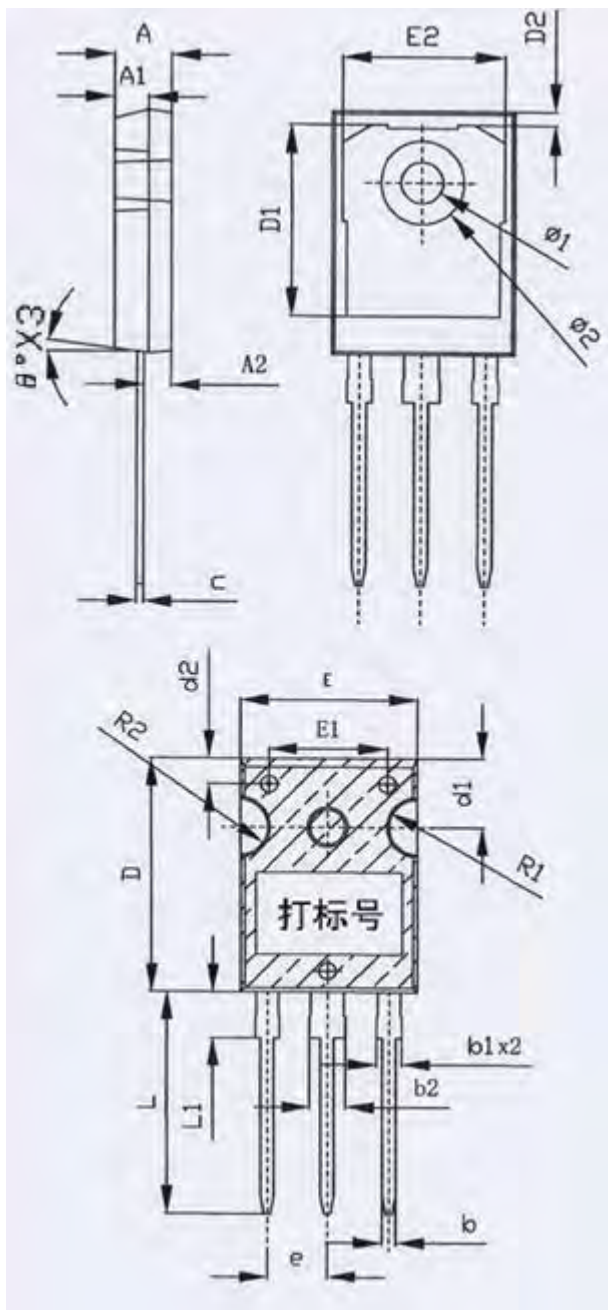
Figure 18. Capacitances vs. Drain-Source Voltage

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handling procedures.



### Package Dimensions

Package TO-247-3L



SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	4.9	5	5.1
A1	2.9	3	3.1
A2	2.31	2.36	2.41
b	1.16	1.2	1.26
b1	2.05	-	2.2
b2	3.05	-	3.2
c	0.58	0.6	0.66
D	20.9	21	21.1
D1	16.46	16.56	16.76
D2		1.17	
d1	6.05	6.15	6.25
d2	2.2	2.3	2.4
E	15.7	15.8	15.9
E1		10.5	
E2		14.02	
e	-	1.27bcs	-
L	19.82	19.92	20.02
L1	1.88	1.98	2.08
$\theta$	0°	7°	8°
R1	-	2.7	-
R2	-	2.5	-
$\Phi 1$		3.6	
$\Phi 2$	-	7.19	-

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